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1 Electrical ratings

Table 2. Absolute maximum ratings

		Valu		
Symbol	Parameter	D ² PAK, TO-220, TO-247	TO220FP, I ² PAKFP	Unit
V_{GS}	Gate-source voltage	± 25		٧
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	34		Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	22		Α
I _{DM} (1),(2)	Drain current (pulsed)	136		Α
P _{TOT}	Total dissipation at T _C = 25 °C	250 40		W
dv/dt (3)	Peak diode recovery voltage slope	15		V/ns
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50		V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T _C =25 °C)	2500		V
T _{stg}	Storage temperature	- 55 to 150		°C
T _j	Max. operating junction temperature	- 55 10	100	°C

- 1. Limited by maximum junction temperature
- 2. Pulse width limited by safe operating area.
- 3. $I_{SD} \leq$ 34 A, di/dt \leq 400 A/ μ s; $V_{DS peak} < V_{(BR)DSS}$, V_{DD} =400 V.
- $4. \quad V_{DS} \leq 480 \ V$

Table 3. Thermal data

		Value				
Symbol	Parameter	D ² PAK	TO-220FP, I ² PAKFP	TO-220	TO-247	Unit
R _{thj-case}	Thermal resistance junction-case max	0.50	3.13	0.50		°C/W
R _{thj-pcb}	Thermal resistance junction-pcb max ⁽¹⁾	30				°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	62.5 50		50	°C/W	

^{1.} When mounted on 1 inch² FR-4, 2 Oz copper board

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})	6	Α
E _{AS}	Single pulse avalanche energy (starting T _j =25°C, I _D = I _{AR} ; V _{DD} =50 V)	500	mJ



2 **Electrical characteristics**

(T_C = 25 °C unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	600			V
I _{DSS}		V _{DS} = 600 V V _{DS} = 600 V, T _C =125 °C			1 100	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 25 V			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2	3	4	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 17 \text{ A}$		0.078	0.088	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	2500	-	pF
C _{oss}	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	117	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	2.4	-	рF
C _{oss eq.} ⁽¹⁾	Equivalent output capacitance	V _{DS} = 0 to 480 V, V _{GS} = 0	-	342	-	pF
R_{G}	Intrinsic gate resistance	f = 1 MHz, I _D = 0	-	4.4	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 34 A,	-	57	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	10	-	nC
Q_{gd}	Gate-drain charge	(see Figure 19)	-	25.5	-	nC

C_{oss eq.} is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 300 V, I _D = 34 A,	ı	20.5	1	ns
t _r	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$	-	13.5	-	ns
t _{d(off)}	Turn-off-delay time	(see Figure 18 and	-	96	-	ns
t _f	Fall time	Figure 23)	-	11	-	ns

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Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-	34		Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-	136		Α
V _{SD} (2)	Forward on voltage	I _{SD} = 34 A, V _{GS} = 0	-		1.6	V
t _{rr}	Reverse recovery time		-	440		ns
Q _{rr}	Reverse recovery charge	$I_{SD} = 34 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 60 \text{ V (see } Figure 23)$	-	8.2		μC
I _{RRM}	Reverse recovery current	100 = 33 1 (333 / igalo 13)	-	37		Α
t _{rr}	Reverse recovery time	I _{SD} = 34 A, di/dt = 100 A/μs	-	568		ns
Q _{rr}	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 ^{\circ}\text{C}$	-	11.5		μC
I _{RRM}	Reverse recovery current	(see Figure 23)	-	40.5		Α

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

2.1 **Electrical characteristics (curves)**

Figure 2. Safe operating area for D²PAK and TO-220

Figure 3. Thermal impedance D²PAK and TO-220

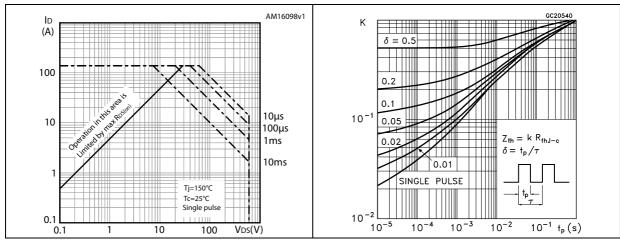


Figure 4. Safe operating area for TO-220FP and Figure 5. Thermal impedance for TO-220FP and I²PAKFP I²PAKFP

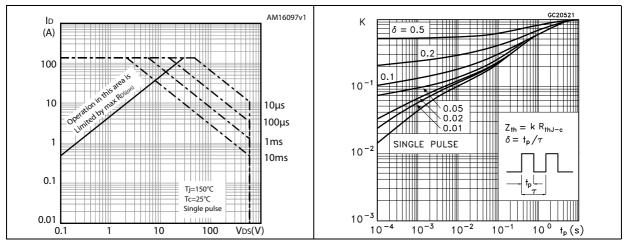


Figure 6. Safe operating area for TO-247

(A)

100

10

GC18460 $\delta = 0.5$ 10- $Z_{th} = k R_{thJ-c}$ $\delta = \, t_{\rm p} / \tau$ SINGLE PULSE

Figure 7. Thermal impedance for TO-247 AM16099v1

Tj=150°C Tc=25°C Single puls 10 V_{DS}(V) 10^{-2} $10^{-1} t_p(s)$ 100

10μs 100µs

1ms

10ms

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4V

20

V_Ds(V)

Figure 8. Output characteristics

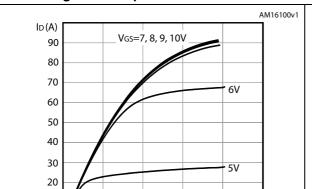


Figure 9. Transfer characteristics

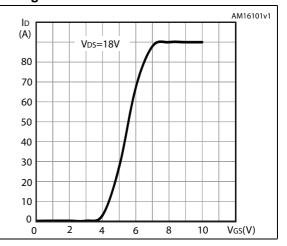
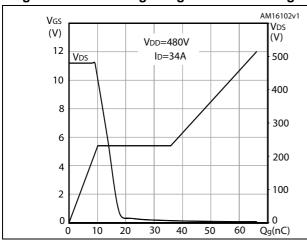


Figure 10. Gate charge vs gate-source voltage

10

0

Figure 11. Static drain-source on-resistance



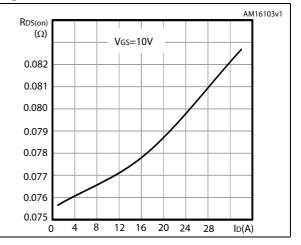
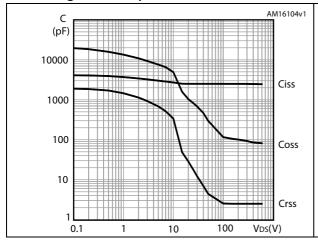
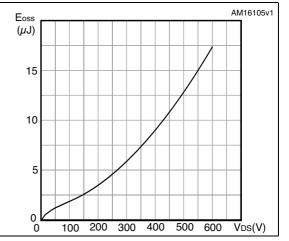


Figure 12. Capacitance variations

Figure 13. Output capacitance stored energy

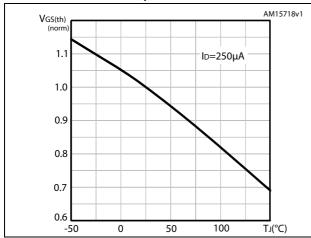




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Figure 14. Normalized gate threshold voltage vs temperature

Figure 15. Normalized on-resistance vs temperature



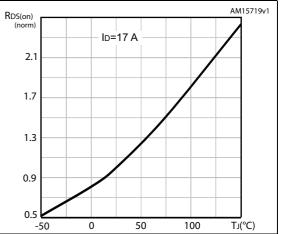
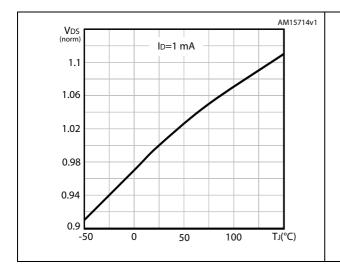
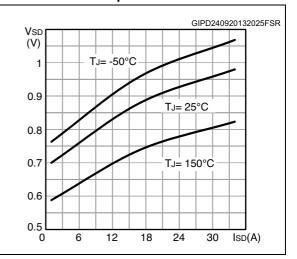


Figure 16. Normalized V_{DS} vs temperature

Figure 17. Source-drain diode forward vs temperature





3 Test circuits

Figure 18. Switching times test circuit for resistive load

Figure 19. Gate charge test circuit

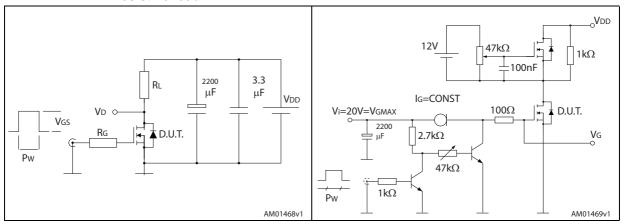


Figure 20. Test circuit for inductive load switching and diode recovery times

Figure 21. Unclamped inductive load test circuit

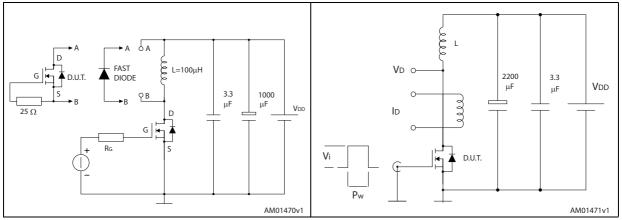
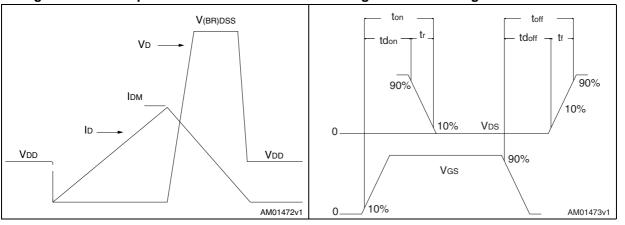


Figure 22. Unclamped inductive waveform

Figure 23. Switching time waveform





4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 9. D²PAK (TO-263) mechanical data

Dim		mm	
Dim. —	Min.	Тур.	Max.
А	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
С	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50		
Е	10		10.40
E1	8.50		
е		2.54	
e1	4.88		5.28
Н	15		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.4	
V2	0°		8°

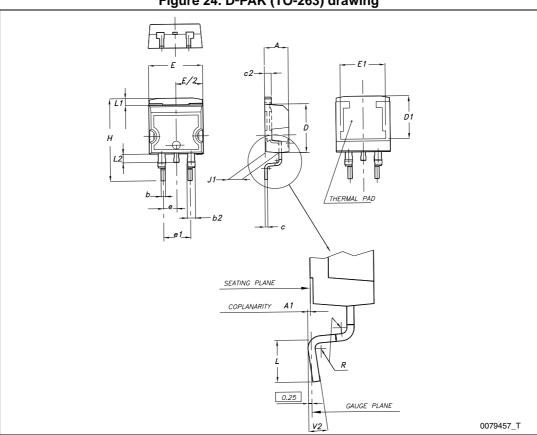
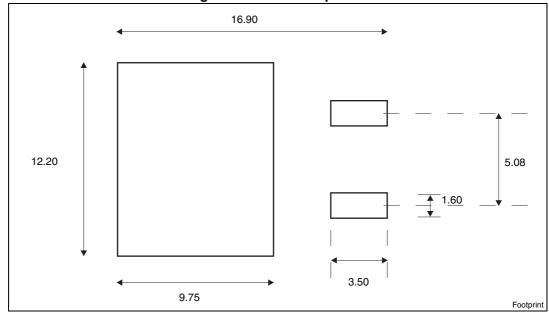


Figure 24. D²PAK (TO-263) drawing





a. All dimension are in millimeters

Table 10. TO-220FP mechanical data

Table 10110 22011 moonamour data				
Dim.		mm		
-	Min.	Тур.	Max.	
Α	4.4		4.6	
В	2.5		2.7	
D	2.5		2.75	
Е	0.45		0.7	
F	0.75		1	
F1	1.15		1.70	
F2	1.15		1.70	
G	4.95		5.2	
G1	2.4		2.7	
Н	10		10.4	
L2		16		
L3	28.6		30.6	
L4	9.8		10.6	
L5	2.9		3.6	
L6	15.9		16.4	
L7	9		9.3	
Dia	3		3.2	

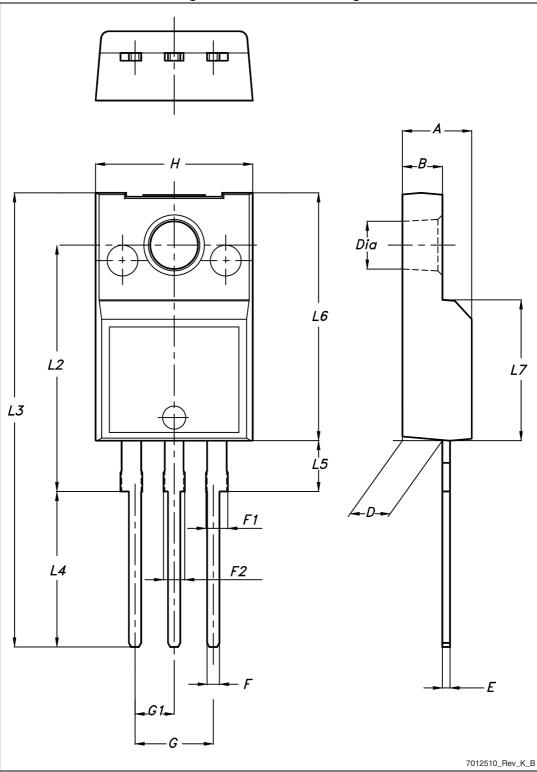
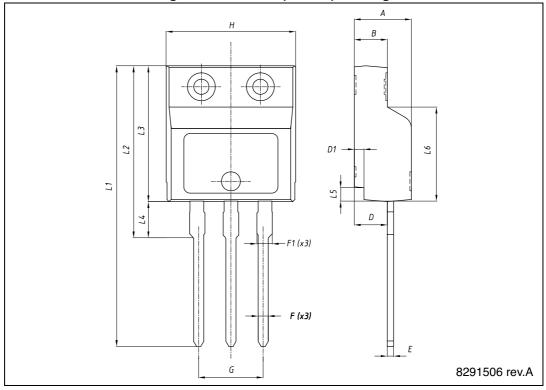


Figure 26. TO-220FP drawing

Table 11. I²PAKFP (TO-281) mechanical data

Dim.		mm				
Dilli.	Min.	Тур.	Max.			
А	4.40		4.60			
В	2.50		2.70			
D	2.50		2.75			
D1	0.65		0.85			
E	0.45		0.70			
F	0.75		1.00			
F1			1.20			
G	4.95	-	5.20			
Н	10.00		10.40			
L1	21.00		23.00			
L2	13.20		14.10			
L3	10.55		10.85			
L4	2.70		3.20			
L5	0.85		1.25			
L6	7.30		7.50			

Figure 27. I²PAKFP (TO-281) drawing





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Table 12. TO-220 type A mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

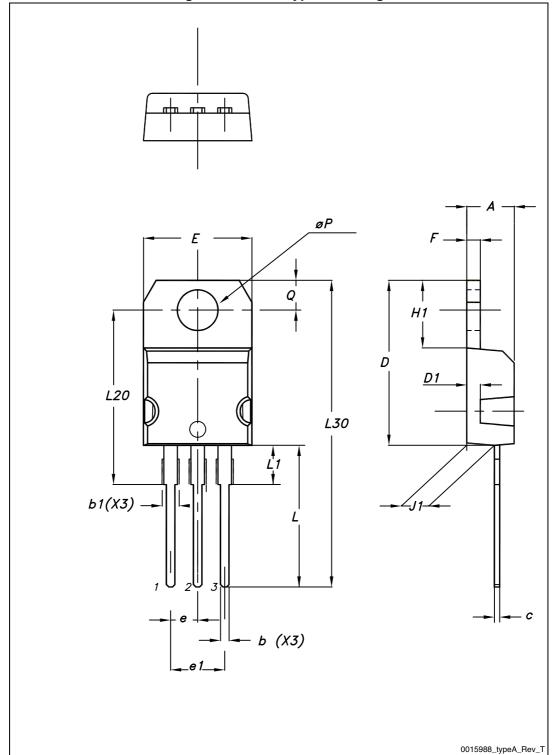


Figure 28. TO-220 type A drawing

Table 13. TO-247 mechanical data

Dim.	mm.				
	Min.	Тур.	Max.		
А	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
E	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		

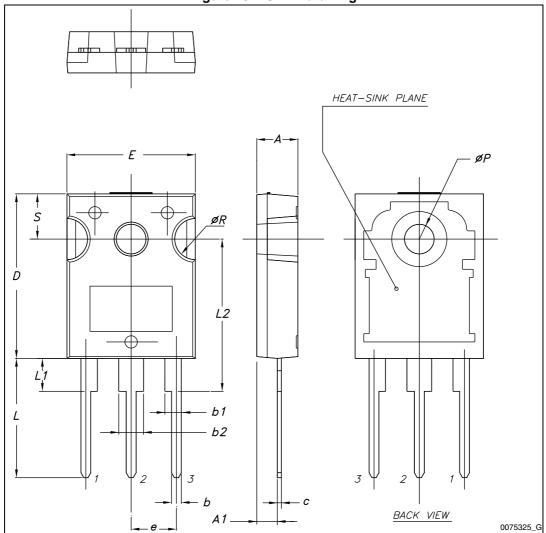


Figure 29. TO-247 drawing

5 Packaging mechanical data

Table 14. D²PAK (TO-263) tape and reel mechanical data

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.	Dilli.	Min.	Max.
A0	10.5	10.7	Α		330
В0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D	20.2	
Е	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1	Base qty 1000		1000
P2	1.9	2.1	Bulk qty 1000		1000
R	50				
Т	0.25	0.35			
W	23.7	24.3]		

Top cover tolerance on tape +/- 0.2 mm

Top cover tolerance on tape +/- 0.2 mm

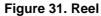
For machine ret. only including draft and radii concentric around B0

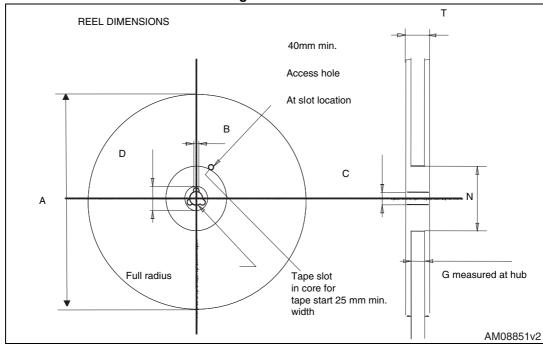
User direction of feed

AM08852v1

AM08852v1

Figure 30. Tape







6 Revision history

Table 15. Document revision history

Date	Revision	Changes
01-Jul-2013	1	First release.
23-Sep-2013	2	 Added: TO-220FP and I²PAKFP packages Inserted: V_{ISO} in <i>Table 2</i> Modified: values in <i>Table 4</i>, the entire typical values in <i>Table 6</i>, 7 and 8 Updated: Section 4: Package mechanical data Minor text changes

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